## LMH6559

High－Speed，Closed－Loop Buffer

## General Description

The LMH6559 is a high－speed，closed－loop buffer designed for applications requiring the processing of very high fre－ quency signals．While offering a small signal bandwidth of 1750 MHz ，and an ultra high slew rate of $4580 \mathrm{~V} / \mu$ s the LMH6559 consumes only 10 mA of quiescent current．Total harmonic distortion into a load of $100 \Omega$ at 20 MHz is -52 dBc ． The LMH6559 is configured internally for a loop gain of one． Input resistance is $200 \mathrm{k} \Omega$ and output resistance is but $1.2 \Omega$ ． These characteristics make the LMH6559 an ideal choice for the distribution of high frequency signals on printed circuit boards．Differential gain and phase specifications of 0．06\％ and $0.02^{\circ}$ respectively at 3.58 MHz make the LMH6559 wel suited for the buffering of video signals．
The device is fabricated on National＇s high－speed VIP10 process using National＇s proven high performance circuit architectures．

## Features

■ Closed－loop buffer
－1750MHz small signal bandwidth
－ $4580 \mathrm{~V} / \mathrm{\mu s}$ slew rate
－ $0.06 \% / 0.02^{\circ}$ differential gain／phase
－-52 dBc THD at 20 MHz
－Single supply operation（3V min．）
－75mA output current

## Applications

－Video switching and routing
－Test point drivers
－High frequency active filters
－Wideband DC clamping buffers
－High－speed peak detector circuits
－Transmission systems
－Telecommunications
－Test equipment and instrumentation

## Typical Schematic



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> Http://www. 100 y. com. tw

## Absolute Maximum Ratings（Note 1） <br> If Military／Aerospace specified devices are required， please contact the National Semiconductor Sales Office／ Distributors for availability and specifications．

| Tolerance（Note 2） |  |
| :---: | :---: |
| Human Body Model | 2000 V |
| Machine Model | 200V |
| Output Short Circuit Duration | （Note 3），（Note 4） |
| Supply Voltage（ $\mathrm{V}^{+}$－ $\mathrm{V}^{-}$） | 13 V |
| Voltage at Input／Output Pins | $\mathrm{V}^{+}+0.8 \mathrm{~V}, \mathrm{~V}^{-}-0.8 \mathrm{~V}$ |
| Soldering Information |  |
| Infrared or Convection（20 sec．） | $235^{\circ} \mathrm{C}$ |


| $\quad$ Wave Soldering（10 sec．） | $260^{\circ} \mathrm{C}$ |
| :--- | ---: |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $+150^{\circ} \mathrm{C}$ |

## Operating Ratings（Note 1）

Supply Voltage $\left(\mathrm{V}^{+}-\mathrm{V}^{-}\right) \quad 3-10 \mathrm{~V}$
Temperature Range（Notes 5，6）$\quad-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Package Thermal Resistance（Notes 5，6）

| 8 －Pin SOIC | $172^{\circ} \mathrm{C} / \mathrm{W}$ |
| :--- | :--- |
| $5-$ Pin SOT23 | $235^{\circ} \mathrm{C} / \mathrm{W}$ |

## $\pm 5 \mathrm{~V}$ Electrical Characteristics

Unless otherwise specified，all limits guaranteed for $T_{J}=25^{\circ} \mathrm{C}, \mathrm{V}^{+}=+5 \mathrm{~V}, \mathrm{~V}^{-}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ and $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to 0 V ． Boldface limits apply at the temperature extremes．

| Symbol | Parameter | Conditions | Min <br> （Note 8） | Typ <br> （Note 7） | Max （Note 8） | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency Domain Response |  |  |  |  |  |  |
| SSBW | Small Signal Bandwidth | $\mathrm{V}_{\mathrm{O}}<0.5 \mathrm{~V}_{\mathrm{PP}}$ |  | 1750 |  | MHz |
| GFN | Gain Flatness＜0．1dB | $\mathrm{V}_{\mathrm{O}}<0.5 \mathrm{~V}_{\mathrm{PP}}$ |  | 200 |  | MHz |
| FPBW | Full Power Bandwidth（－3dB） | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}(+10 \mathrm{dBm})$ |  | 1050 |  | MHZ |
| DG | Differential Gain | $\begin{aligned} & R_{L}=150 \Omega \text { to } 0 V, \\ & f=3.58 \mathrm{MHz} \end{aligned}$ |  | 0.06 |  | \％ |
| DP | Differential Phase | $\begin{aligned} & R_{L}=150 \Omega \text { to } 0 V, \\ & \mathrm{f}=3.58 \mathrm{MHz} \end{aligned}$ |  | 0.02 |  | deg |
| Time Domain Response |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{r}}$ | Rise Time | 3．3V Step（20－80\％） |  | 0.4 |  | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time |  |  | 0.5 |  | ns |
| $\mathrm{t}_{\mathrm{s}}$ | Settling Time to $\pm 0.1 \%$ | 3．3V Step |  | 9 | － | ns |
| OS | Overshoot | 1V Step |  | 4 |  | \％ |
| SR | Slew Rate | （Note 10） |  | 4580 |  | V／$/ \mathrm{s}$ |
| Distortion And Noise Performance |  |  |  |  |  |  |
| HD2 | $2^{\text {nd }}$ Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}, \mathrm{f}=20 \mathrm{MHz}$ |  | －58 |  | dBc |
| HD3 | $33^{\text {rd }}$ Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}, \mathrm{f}=20 \mathrm{MHz}$ |  | －53 |  | dBc |
| THD | Total Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}, \mathrm{f}=20 \mathrm{MHz}$ |  | －52 |  | dBc |
| $\mathrm{e}_{\mathrm{n}}$ | Input－Referred Voltage Noise | $\mathrm{f}=1 \mathrm{MHz}$ |  | 5.7 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| CP | 1dB Compression point | $\mathrm{f}=10 \mathrm{MHz}$ |  | ＋23 |  | dBm |
| SNR | Signal to Noise Ratio | $\begin{aligned} & \mathrm{f}>100 \mathrm{kHz}, \mathrm{BW}=5 \mathrm{MHz}, \\ & \mathrm{~V}_{\mathrm{O}}=350 \mathrm{mVrms} \end{aligned}$ |  | 89 |  | dB |
| Static，DC Performance |  |  |  |  |  |  |
| $\mathrm{A}_{\mathrm{CL}}$ | Small Signal Voltage Gain | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=100 \mathrm{~m} \mathrm{~V}_{\mathrm{PP}} \\ & \mathrm{R}_{\mathrm{L}}=100 \Omega \text { to } 0 \mathrm{~V} \\ & \hline \end{aligned}$ | ． 97 | ． 996 |  | V／V |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=100 \mathrm{~m} \mathrm{~V}_{\mathrm{PP}} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to } 0 \mathrm{~V} \\ & \hline \end{aligned}$ | ． 99 | ． 998 |  |  |
| $\mathrm{V}_{\text {OS }}$ | Input Offset Voltage |  |  | 3 | $\begin{aligned} & 20 \\ & 25 \end{aligned}$ | mV |
| TC V ${ }_{\text {os }}$ | Temperature Coefficient Input Offset Voltage | （Note 11） |  | 23 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{I}_{\mathrm{B}}$ | Input Bias Current | （Note 9） | $\begin{aligned} & \hline-10 \\ & -14 \\ & \hline \end{aligned}$ | －3 |  | $\mu \mathrm{A}$ |
| TC IB | Temperature Coefficient Input Bias Current | （Note 11） |  | －3．6 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |

$\pm 5 \mathrm{~V}$ Electrical Characteristics（Continued）
Unless otherwise specified，all limits guaranteed for $T_{J}=25^{\circ} \mathrm{C}, \mathrm{V}^{+}=+5 \mathrm{~V}, \mathrm{~V}^{-}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ and $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to 0 V ．
Boldface limits apply at the temperature extremes．

| Symbol | Parameter | Conditions | $\begin{gathered} \text { Min } \\ (\text { Note 8) } \end{gathered}$ | Typ （Note 7） | $\begin{aligned} & \text { Max } \\ & \text { (Note 8) } \end{aligned}$ | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{\text {OUT }}$ | Output Resistance | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $0 \mathrm{~V}, \mathrm{f}=100 \mathrm{kHz}$ |  | 1.2 |  | $\Omega$ |
|  |  | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $0 \mathrm{~V}, \mathrm{f}=10 \mathrm{MHz}$ |  | 1.3 |  |  |
| PSRR | Power Supply Rejection Ratio | $\mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{S}}= \pm 5.25 \mathrm{~V}$ | $\begin{aligned} & 48 \\ & 44 \end{aligned}$ | 63 |  | dB |
| $\mathrm{I}_{\text {s }}$ | Supply Current | No Load |  | 10 | $\begin{aligned} & \hline 14 \\ & 17 \end{aligned}$ | mA |
| Miscellaneous Performance |  |  |  |  |  |  |
| $\mathrm{R}_{\text {IN }}$ | Input Resistance |  |  | 200 |  | $\mathrm{k} \Omega$ |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 1.7 |  | pF |
| $\mathrm{V}_{\mathrm{O}}$ | Output Swing Positive | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to 0 V | $\begin{aligned} & 3.20 \\ & 3.18 \end{aligned}$ | 3.45 |  | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to 0 V | $\begin{aligned} & 3.55 \\ & 3.54 \end{aligned}$ | 3.65 |  |  |
|  | Output Swing Negative | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to 0 V |  | －3．45 | $\begin{aligned} & -3.20 \\ & -3.18 \end{aligned}$ | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to 0 V |  | －3．65 | $\begin{aligned} & -3.55 \\ & -3.54 \end{aligned}$ |  |
| $\mathrm{I}_{\mathrm{Sc}}$ | Output Short Circuit Current | Sourcing： $\mathrm{V}_{\text {IN }}=+\mathrm{V}_{\mathrm{S}}, \mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ |  | －83 |  | mA |
|  |  | Sinking： $\mathrm{V}_{\text {IN }}=-\mathrm{V}_{\mathrm{S}}, \mathrm{V}_{\mathrm{O}}=0 \mathrm{~V}$ |  | 83 |  |  |
| $\mathrm{I}_{0}$ | Linear Output Current | Sourcing： $\mathrm{V}_{\mathrm{IN}}-\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ （Note 9） | $\begin{aligned} & \hline-50 \\ & -43 \end{aligned}$ | －74 |  | mA |
|  |  | Sinking： $\mathrm{V}_{\mathrm{IN}}-\mathrm{V}_{\mathrm{O}}=-0.5 \mathrm{~V}$ （Note 9） | $\begin{aligned} & 50 \\ & 43 \end{aligned}$ | 74 |  |  |

## 5V Electrical Characteristics

Unless otherwise specified，all limits guaranteed for $\mathrm{T}_{J}=25^{\circ} \mathrm{C}, \mathrm{V}^{+}=5 \mathrm{~V}, \mathrm{~V}^{-}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CM}}=\mathrm{V}^{+} / 2$ and $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ ．
Boldface limits apply at the temperature extremes．

| Symbol | Parameter | Conditions | $\begin{gathered} \text { Min } \\ (\text { Note 8) } \end{gathered}$ | $\begin{aligned} & \text { Typ } \\ & \text { (Note 7) } \end{aligned}$ | Max （Note 8） | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency Domain Response |  |  |  |  |  |  |
| SSBW | Small Signal Bandwidth | $\mathrm{V}_{\mathrm{O}}<0.5 \mathrm{~V}_{\mathrm{PP}}$ |  | 745 |  | MHz |
| GFN | Gain Flatness＜0．1dB | $\mathrm{V}_{\mathrm{O}}<0.5 \mathrm{~V}_{\mathrm{PP}}$ |  | 90 |  | MHz |
| FPBW | Full Power Bandwidth（－3dB） | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}(+10 \mathrm{dBm})$ |  | 485 |  | MHZ |
| DG | Differential Gain | $\begin{aligned} & R_{L}=150 \Omega \text { to } V^{+} / 2, \\ & f=3.58 \mathrm{MHz} \end{aligned}$ |  | 0.29 |  | \％ |
| DP | Differential Phase | $\begin{aligned} & R_{L}=150 \Omega \text { to } \mathrm{V}^{+} / 2, \\ & \mathrm{f}=3.58 \mathrm{MHz} \end{aligned}$ |  | 0.06 |  | deg |
| Time Domain Response |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{r}}$ | Rise Time | $2.3 \mathrm{~V}_{\text {PP }}$ Step（20－80\％） |  | 0.6 |  | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time |  |  | 0.9 |  | ns |
| $\mathrm{t}_{\mathrm{s}}$ | Settling Time to $\pm 0.1 \%$ | 2．3V Step |  | 9.6 |  | ns |
| OS | Overshoot | 1V Step |  | 3 |  | \％ |
| SR | Slew Rate | （Note 10） |  | 2070 |  | V／$\mu \mathrm{s}$ |
| Distortion And Noise Performance |  |  |  |  |  |  |
| HD2 | $2^{\text {nd }}$ Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\text {PP }}, \mathrm{f}=20 \mathrm{MHz}$ |  | －53 |  | dBc |
| HD3 | $3{ }^{\text {rd }}$ Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}, \mathrm{f}=20 \mathrm{MHz}$ |  | －56 |  | dBc |
| THD | Total Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}, \mathrm{f}=20 \mathrm{MHz}$ |  | －52 |  | dBc |
| $\mathrm{e}_{\mathrm{n}}$ | Input－Referred Voltage Noise | $\mathrm{f}=1 \mathrm{MHz}$ |  | 4.0 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |

5V Electrical Characteristics（Continued）
Unless otherwise specified，all limits guaranteed for $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}, \mathrm{V}^{+}=5 \mathrm{~V}, \mathrm{~V}^{-}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CM}}=\mathrm{V}^{+} / 2$ and $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ ． Boldface limits apply at the temperature extremes．

| Symbol | Parameter | Conditions | Min <br> （Note 8） | Typ <br> $($ Note 7） | Max <br> $($ Note 8$)$ | Units |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| CP | 1dB Compression point | $\mathrm{f}=10 \mathrm{MHz}$ |  | +7 |  | dBm |
| SNR | Signal to Noise Ratio | $\mathrm{f}>100 \mathrm{kHz}, \mathrm{BW}=5 \mathrm{MHz}$, <br> $\mathrm{V}_{\mathrm{O}}=350 \mathrm{mVrms}$ |  | 92 |  | dB |

Static，DC Performance

| $\mathrm{A}_{\mathrm{CL}}$ | Small Signal Voltage Gain | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=100 \mathrm{mV}_{\mathrm{PP}} \\ & \mathrm{R}_{\mathrm{L}}=100 \Omega \text { to } \mathrm{V}^{+} / 2 \end{aligned}$ | ． 97 | ． 996 |  | V／V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=100 \mathrm{mV}_{\mathrm{PP}} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to } \mathrm{V}^{+} / 2 \end{aligned}$ | ． 99 | ． 998 |  |  |
| $\mathrm{V}_{\text {OS }}$ | Input Offset Voltage |  |  | 1.52 | $\begin{aligned} & 12 \\ & 16 \end{aligned}$ | mV |
| TC V ${ }_{\text {Os }}$ | Temperature Coefficient Input Offset Voltage | （Note 11） |  | 23 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $I_{B}$ | Input Bias Current | （Note 9） | $\begin{aligned} & \hline-5 \\ & -8 \end{aligned}$ | －2．7 |  | $\mu \mathrm{A}$ |
| TC IB | Temperature Coefficient Input Bias Current | （Note 11） |  | 1.6 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{R}_{\text {OUT }}$ | Output Resistance | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2, \mathrm{f}=100 \mathrm{kHz}$ |  | 1.4 |  | $\Omega$ |
|  |  | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2, \mathrm{f}=10 \mathrm{MHz}$ |  | 1.6 |  |  |
| PSRR | Power Supply Rejection Ratio | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{S}}=+5.5 \mathrm{~V}, \\ & \mathrm{~V}_{\text {IN }}=\mathrm{V}_{\mathrm{S}} / 2 \end{aligned}$ | $\begin{aligned} & 48 \\ & 44 \end{aligned}$ | 68 |  | dB |
| $\mathrm{I}_{\mathrm{s}}$ | Supply Current | No Load |  | 4.7 | $\begin{gathered} 7 \\ 8.5 \end{gathered}$ | mA |


| Miscellaneous Performance |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{\mathrm{IN}}$ | Input Resistance |  |  | 22 | 1. | k $\Omega$ |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 2.0 |  | pF |
| $\mathrm{V}_{0}$ | Output Swing Positive | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ | $\begin{aligned} & 3.80 \\ & 3.75 \end{aligned}$ | 3.88 |  | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to $\mathrm{V}^{+} / 2$ | $\begin{aligned} & \hline 3.94 \\ & 3.92 \end{aligned}$ | 3.98 |  |  |
|  | Output Swing Negative | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ |  | 1.12 | $\begin{aligned} & 1.20 \\ & 1.25 \end{aligned}$ | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to $\mathrm{V}^{+} / 2$ |  | 1.03 | $\begin{aligned} & 1.06 \\ & 1.09 \end{aligned}$ |  |
| $\mathrm{I}_{\text {sc }}$ | Output short circuit Current | Sourcing： $\mathrm{V}_{\text {IN }}=+\mathrm{V}_{\mathrm{S}}, \mathrm{V}_{\mathrm{O}}=\mathrm{V}^{+} / 2$ |  | －57 |  | mA |
|  |  | Sinking： $\mathrm{V}_{\text {IN }}=-\mathrm{V}_{\mathrm{S}}, \mathrm{V}_{\mathrm{O}}=\mathrm{V}^{+} / 2$ |  | 26 |  |  |
| $\mathrm{I}_{0}$ | Linear Output Current | Sourcing： $\mathrm{V}_{\mathrm{IN}}-\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ （Note 9） | $\begin{aligned} & -50 \\ & -43 \end{aligned}$ | －64 |  | mA |
|  |  | Sinking： $\mathrm{V}_{\mathrm{IN}}-\mathrm{V}_{\mathrm{O}}=-0.5 \mathrm{~V}$ （Note 9） | $\begin{aligned} & 30 \\ & 23 \end{aligned}$ | 42 |  |  |

## 3V Electrical Characteristics

Unless otherwise specified，all limits guaranteed for $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}, \mathrm{V}^{+}=3 \mathrm{~V}, \mathrm{~V}^{-}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CM}}=\mathrm{V}^{+} / 2$ and $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ ． Boldface limits apply at the temperature extremes．

| Symbol | Parameter | Conditions | $\begin{gathered} \text { Min } \\ \text { (Note 8) } \end{gathered}$ | $\begin{gathered} \text { Typ } \\ \text { (Note 7) } \end{gathered}$ | $\begin{gathered} \text { Max } \\ \text { (Note 8) } \end{gathered}$ | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency Domain Response |  |  |  |  |  |  |
| SSBW | Small Signal Bandwidth | $\mathrm{V}_{\mathrm{O}}<0.5 \mathrm{~V}_{\mathrm{PP}}$ |  | 315 |  | MHz |
| GFN | Gain Flatness＜0．1dB | $\mathrm{V}_{\mathrm{O}}<0.5 \mathrm{~V}_{\mathrm{PP}}$ |  | 44 |  | MHz |

## 3V Electrical Characteristics（Continued）

Unless otherwise specified，all limits guaranteed for $T_{J}=25^{\circ} \mathrm{C}, \mathrm{V}^{+}=3 \mathrm{~V}, \mathrm{~V}^{-}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CM}}=\mathrm{V}^{+} / 2$ and $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ ． Boldface limits apply at the temperature extremes．

| Symbol | Parameter | Conditions | $\begin{gathered} \text { Min } \\ (\text { Note 8) } \end{gathered}$ | Typ （Note 7） | Max （Note 8） | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FPBW | Full Power Bandwidth（－3dB） | $\mathrm{V}_{\mathrm{O}}=1 \mathrm{~V}_{\mathrm{PP}}(+4.5 \mathrm{dBm})$ |  | 265 |  | MHZ |
| Time Domain Response |  |  |  |  |  |  |
| $\mathrm{t}_{\mathrm{r}}$ | Rise Time | 1．0V Step（20－80\％） |  | 0.8 |  | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time |  |  | 1.2 |  | ns |
| $\mathrm{t}_{\mathrm{s}}$ | Settling Time to $\pm 0.1 \%$ | 1V Step |  | 10 |  | ns |
| OS | Overshoot | 0．5V Step |  | 0 |  | \％ |
| SR | Slew Rate | （Note 10） |  | 770 |  | V／$/$ s |
| Distortion And Noise Performance |  |  |  |  |  |  |
| HD2 | $2^{\text {nd }}$ Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}, \mathrm{f}=20 \mathrm{MHz}$ |  | －74 |  | dBc |
| HD3 | $3{ }^{\text {rd }}$ Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\text {PP }}, \mathrm{f}=20 \mathrm{MHz}$ |  | －57 |  | dBc |
| THD | Total Harmonic Distortion | $\mathrm{V}_{\mathrm{O}}=2 \mathrm{~V}_{\mathrm{PP}}, \mathrm{f}=20 \mathrm{MHz}$ |  | －56 |  | dBc |
| $\mathrm{e}_{\mathrm{n}}$ | Input－Referred Voltage Noise | $\mathrm{f}=1 \mathrm{MHz}$ |  | 3.9 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| CP | 1dB Compression point | $\mathrm{f}=10 \mathrm{MHz}$ |  | ＋4 |  | dBm |
| SNR | Signal to Noise Ratio | $\begin{aligned} & \mathrm{f}>100 \mathrm{kHz}, \mathrm{BW}=5 \mathrm{MHz}, \\ & \mathrm{~V}_{\mathrm{O}}=350 \mathrm{mVrms} \end{aligned}$ |  | 92 |  | dB |

Static，DC Performance

| $\mathrm{A}_{\mathrm{CL}}$ | Small Signal Voltage Gain | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=100 \mathrm{mV} \mathrm{~V}_{\mathrm{PP}} \\ & \mathrm{R}_{\mathrm{L}}=100 \Omega \text { to } \mathrm{V}^{+} / 2 \\ & \hline \end{aligned}$ | ． 97 | ． 995 |  | V／V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=100 \mathrm{mV}_{\mathrm{PP}} \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \text { to } \mathrm{V}^{+} / 2 \end{aligned}$ | ． 99 | ． 998 |  |  |
| $\mathrm{V}_{\text {Os }}$ | Input Offset Voltage |  |  | 1 | 7 | mV |
| TC V ${ }_{\text {os }}$ | Temperature Coefficient Input Offset Voltage | （Note 11） |  | 3.5 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{I}_{\mathrm{B}}$ | Input Bias Current | （Note 9） | $\begin{gathered} \hline-3 \\ -3.5 \end{gathered}$ | －1．5 |  | $\mu \mathrm{A}$ |
| $\mathrm{TC} \mathrm{I}_{\mathrm{B}}$ | Temperature Coefficient Input Bias Current | （Note 11） |  | 0.46 |  | $\mathrm{nA} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{R}_{\text {OUT }}$ | Output Resistance | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2, \mathrm{f}=100 \mathrm{kHz}$ |  | 1.8 |  | $\Omega$ |
|  |  | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2, \mathrm{f}=10 \mathrm{MHz}$ |  | 2.3 |  | $\Omega$ |
| PSRR | Power Supply Rejection Ratio | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=+3 \mathrm{~V} \text { to } \mathrm{V}_{\mathrm{S}}=+3.5 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}^{+} / 2 \end{aligned}$ | $\begin{aligned} & 48 \\ & 46 \\ & \hline \end{aligned}$ | 68 |  | dB |
| $\mathrm{I}_{\text {S }}$ | Supply Current | No Load |  | 2.4 | $\begin{aligned} & 3.5 \\ & 4.5 \end{aligned}$ | mA |

Miscellaneous Performance

| $\mathrm{R}_{\text {IN }}$ | Input Resistance |  | U | 23 |  | $\mathrm{k} \Omega$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 2.3 |  | pF |
| $\mathrm{V}_{\text {O }}$ | Output Swing Positive | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ | $\begin{aligned} & 2.02 \\ & 1.95 \end{aligned}$ | 2.07 |  | v |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to $\mathrm{V}^{+} / 2$ | $\begin{aligned} & 2.12 \\ & 2.02 \end{aligned}$ | 2.17 |  |  |
|  | Output Swing Negative | $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ |  | ． 930 | $\begin{gathered} .970 \\ 1.050 \\ \hline \end{gathered}$ | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ to $\mathrm{V}^{+} / 2$ |  | ． 830 | $\begin{aligned} & .880 \\ & .980 \end{aligned}$ |  |
| $I_{\text {sc }}$ | Output Short Circuit Current | Sourcing： $\mathrm{V}_{\text {IN }}=+\mathrm{V}_{\mathrm{S}}, \mathrm{V}_{\mathrm{O}}=\mathrm{V}^{+} / 2$ |  | －32 |  | mA |
|  |  | Sinking： $\mathrm{V}_{\text {IN }}=-\mathrm{V}_{\mathrm{S}}, \mathrm{V}_{\mathrm{O}}=\mathrm{V}^{+} / 2$ |  | 15 |  |  |

Unless otherwise specified，all limits guaranteed for $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}, \mathrm{V}^{+}=3 \mathrm{~V}, \mathrm{~V}^{-}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CM}}=\mathrm{V}^{+} / 2$ and $\mathrm{R}_{\mathrm{L}}=100 \Omega$ to $\mathrm{V}^{+} / 2$ ． Boldface limits apply at the temperature extremes．

| Symbol | Parameter | Conditions | $\begin{gathered} \text { Min } \\ (\text { Note 8) } \end{gathered}$ | $\begin{aligned} & \text { Typ } \\ & \text { (Note 7) } \end{aligned}$ | $\begin{gathered} \text { Max } \\ \text { (Note 8) } \end{gathered}$ | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{0}$ | Linear Output Current | Sourcing： $\mathrm{V}_{\mathrm{IN}}-\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ <br> （Note 9） | $\begin{aligned} & \hline-20 \\ & -13 \end{aligned}$ | －28 |  | mA |
|  |  | Sinking： $\mathrm{V}_{\mathrm{IN}}-\mathrm{V}_{\mathrm{O}}=-0.5 \mathrm{~V}$ （Note 9） | $\begin{gathered} 12 \\ 8 \end{gathered}$ | 17 |  |  |

Note 1：Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed．They are not meant to imply that the devices should be operated at these limits．The table of＂Electrical Characteristics＂specifies conditions of device operation．
Note 2：Human Body Model，applicable std．MIL－STD－883，Method 3015．7．Machine Model，applicable std．JESD22－A115－A（ESD MM std．of JEDEC） Field－Induced Charge－Device Model，applicable std．JESD22－C101－C（ESD FICDM std．of JEDEC）．
Note 3：Applies to both single－supply and split－supply operation．Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of $150^{\circ} \mathrm{C}$ ．
Note 4：Short circuit test is a momentary test．See next note．
Note 5：The maximum power dissipation is a function of $T_{J(M A X)}, \theta_{J A}$ ，and $T_{A}$ ．The maximum allowable power dissipation at any ambient temperature is $P_{D}=$ $\left(T_{J(M A X)}-T_{A}\right) / \theta_{J A}$ ．All numbers apply for packages soldered directly onto a PC board．
Note 6：Electrical Table values apply only for factory testing conditions at the temperature indicated．Factory testing conditions result in very limited self－heating of the device such that $T_{J}=T_{A}$ ．There is no guarantee of parametric performance as indicated in the electrical tables under conditions of internal self－heating where $T_{J}>T_{A}$ ．See Applications section for information on temperature de－rating of this device．
Note 7：Typical values represent the most likely parametric norm as determined at the time of characterization．Actual typical values may vary over time and will also depend on the application and configuration．The typical values are not tested and are not guaranteed on shipped production material．
Note 8：All limits are guaranteed by testing or statistical analysis．
Note 9：Positive current corresponds to current flowing into the device．
Note 10：Slew rate is the average of the positive and negative slew rate．
Note 11：Average Temperature Coefficient is determined by dividing the change in a parameter at temperature extremes by the total temperature change．

## Connection Diagrams


5－Pin SOT23


## Ordering Information

| Package | Part Number | Package Marking | Transport Media | NSC Drawing |
| :---: | :---: | :---: | :---: | :---: |
| 8－Pin SOIC | LMH6559MA | LMH6559MA | 95 Units／Rail | M08A |
|  | LMH6559MAX |  |  |  |
|  | 5－Pin SOT23 | LMH6559MF | B05A | 2．5k Units Tape and Reel |
|  | LMH6559MFX |  |  | MF05A |
|  |  |  |  |  |

[^0]Typical Performance Characteristics At $\mathrm{T}_{J}=25^{\circ} \mathrm{C} ; \mathrm{V}^{+}=+5 \mathrm{~V} ; \mathrm{V}^{-}=-5 \mathrm{~V} ;$ Unless otherwise speci－ fied．


20064101

## Gain Flatness



Differential Gain and Phase


Frequency Response Over Temperature


20064132
Differential Gain and Phase


20064103

Transient Response Positive


Typical Performance Characteristics $\mathrm{At}^{\mathrm{T}} \mathrm{T}_{\mathrm{L}} 25^{\circ} \mathrm{C} ; \mathrm{V}^{+}=+5 \mathrm{~V} ; \mathrm{V}^{-}=-5 \mathrm{~V}$ ；Unless otherwise specified．（Continued）


20064108
Transient Response Negative for Various $V_{\text {supply }}$


Harmonic Distortion vs． $\mathrm{V}_{\text {Out }}$＠10MHz


Transient Response Positive for Various $\mathbf{V}_{\text {supply }}$


20064106
Harmonic Distortion vs． $\mathrm{V}_{\text {Out }} @ 5 \mathrm{MHz}$


20064109
Harmonic Distortion vs． $\mathrm{V}_{\text {out }}$＠20MHz


Typical Performance Characteristics $\mathrm{At}_{\mathrm{T}}=25^{\circ} \mathrm{C} ; \mathrm{V}^{+}=+5 \mathrm{~V} ; \mathrm{V}^{-}=-5 \mathrm{~V}$ ；Unless otherwise specified．（Continued）

THD vs． $\mathrm{V}_{\text {Out }}$ for Various Frequencies


2006411


20064112


Voltage Noise


20064113


20064122
$\mathrm{V}_{\text {Os }}$ vs． $\mathrm{V}_{\text {SUPPLY }}$ for Unit 2


Typical Performance Characteristics $\mathrm{At}^{\mathrm{T}} \mathrm{T}_{\mathrm{L}} 25^{\circ} \mathrm{C} ; \mathrm{V}^{+}=+5 \mathrm{~V} ; \mathrm{V}^{-}=-5 \mathrm{~V}$ ；Unless otherwise specified．（Continued）


20064125
$R_{\text {Out }}$ vs．Frequency


20064115
$I_{\text {SUPPLY }}$ vs． $\mathbf{V}_{\text {SUPPLY }}$

$I_{B}$ vs． $\mathbf{V}_{\text {Supply }}$（Note 9）


20064126
PSRR vs．Frequency


20064116
$I_{\text {supply }}$ vs． $\mathrm{V}_{\mathrm{IN}}$


Typical Performance Characteristics $\mathrm{At}_{\mathrm{T}}=25^{\circ} \mathrm{C} ; \mathrm{V}^{+}=+5 \mathrm{~V} ; \mathrm{V}^{-}=-5 \mathrm{~V}$ ；Unless otherwise specified．（Continued）


20064128

## $I_{o}$ Sinking vs．$V_{\text {suppLy }}$



20064131
Small Signal Pulse Response



20064129
$I_{0}$ Sourcing vs．$V_{\text {supply }}$


20064130
Large Signal Pulse Response＠ $\mathbf{V}_{\mathrm{S}}=3 \mathrm{~V}$


Typical Performance Characteristics $\mathrm{At}_{\mathrm{T}}=25^{\circ} \mathrm{C} ; \mathrm{V}^{+}=+5 \mathrm{~V} ; \mathrm{V}^{-}=-5 \mathrm{~V}$ ；Unless otherwise specified．（Continued）


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## Application Notes

## USING BUFFERS

A buffer is an electronic device delivering current gain but no voltage gain．It is used in cases where low impedances need to be driven and more drive current is required．Buffers need a flat frequency response and small propagation delay．Fur－ thermore，the buffer needs to be stable under resistive， capacitive and inductive loads．High frequency buffer appli－ cations require that the buffer be able to drive transmission lines and cables directly．

## IN WHAT SITUATION WILL WE USE A BUFFER？

In case of a signal source not having a low output impedance one can increase the output drive capability by using a buffer．For example，an oscillator might stop working or have frequency shift which is unacceptably high when loaded heavily．A buffer should be used in that situation．Also in the case of feeding a signal to an A／D converter it is recom－ mended that the signal source be isolated from the $A / D$ converter．Using a buffer assures a low output impedance， the delivery of a stable signal to the converter，and accom－ modation of the complex and varying capacitive loads that the $A / D$ converter presents to the OpAmp．Optimum value is often found by experimentation for the particular application．
The use of buffers is strongly recommended for the handling of high frequency signals，for the distribution of signals through transmission lines or on pcb＇s，or for the driving of external equipment．There are several driving options：
－Use one buffer to drive one transmission line（see Figure 1）
－Use one buffer to drive to multiple points on one trans－ mission line（see Figure 2）
－Use one buffer to drive several transmission lines each driving a different receiver．（see Figure 3）


FIGURE 1.



## FIGURE 3.

In these three options it is seen that there is more than one preferred method to reach an（end）point on a transmission line．Until a certain point the designer can make his own choice but the designer should keep in mind never to break the rules about high frequency transport of signals．An ex－ planation follows in the text below．

## TRANSMISSION LINES

Introduction to transmission lines．The following is an over－ view of transmission line theory．Transmission lines can be used to send signals from DC to very high frequencies．At all points across the transmission line，Ohm＇s law must apply． For very high frequencies，parasitic behavior of the PCB or cables comes into play．The type of cable used must match the application．For example an audio cable looks like a coax cable but is unusable for radar frequencies at 10 GHz ．In this case one have to use special coax cables with lower attenu－ ation and radiation characteristics．
Normally a pcb trace is used to connect components on a pcb board together．An important considerations is the amount of current carried by these pcb traces．Wider pcb traces are required for higher current densities and for ap－ plications where very low series resistance is needed．When routed over a ground plane，pcb traces have a defined Characteristic Impedance．In many design situations char－ acteristic impedance is not utilized．In the case of high frequency transmission，however it is necessary to match the load impedance to the line characteristic impedance （more on this later）．Each trace is associated with a certain amount of series resistance and series inductance plus each trace exhibits parallel capacitance to the ground plane．The combination of these parameters defines the line＇s charac－ teristic impedance．The formula with which we calculate this impedance is as follows：
$Z_{0}=\sqrt{ }(L / C)$
In this formula $L$ and $C$ are the value／unit length，and $R$ is assumed to be zero．$C$ and $L$ are unknown in many cases so we have to follow other steps to calculate the $Z_{0}$ ．The char－ acteristic impedance is a function of the geometry of the cross section of the line．In（Figure 4）we see three cross sections of commonly used transmission lines．

FIGURE 2.

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## Application Notes（Continued）



## FIGURE 4.

$Z_{0}$ can be calculated by knowing some of the physical di－ mensions of the pcb line，such as pcb thickness，width of the trace and $\epsilon_{\mathrm{r}}$ ，relative dielectric constant．The formula given in transmission line theory for calculating $\mathrm{Z}_{\mathrm{O}}$ is as follows：

$$
\begin{equation*}
Z=\frac{87}{\sqrt{(\varepsilon r+1.41)}} \times \ln \frac{(5.98 \times h)}{(\text { th }+0.8 W)} \tag{1}
\end{equation*}
$$

$\epsilon_{\mathrm{r}}$ relative dielectric constant
h pcb height
W trace width
th thickness of the copper
If we ignore the thickness of the copper in comparison to the width of the trace then we have the following equation：

$$
\begin{equation*}
Z=\frac{87}{\sqrt{(\varepsilon r+1.41)}} \times \ln \frac{(5.98 \times h)}{(0.8 W)} \tag{2}
\end{equation*}
$$

With this formula it is possible to calculate the line imped－ ance vs．the trace width．Figure 5 shows the impedance associated with a given line width．Using the same formula it is also possible to calculate what happens when $\epsilon_{\mathrm{r}}$ varies over a certain range of values．Varying the $\epsilon_{\mathrm{r}}$ over a range of 1 to 10 gives a variation for the Characteristic Impedance of about $40 \Omega$ from $80 \Omega$ to $38 \Omega$ ．Most transmission lines are designed to have $50 \Omega$ or $75 \Omega$ impedance．The reason for that is that in many cases the pcb trace has to connect to a cable whose impedance is either $50 \Omega$ or $75 \Omega$ ．As shown $\epsilon_{r}$ and the line width influence this value．

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FIGURE 5.
Next，there will be a discussion of some issues associated with the interaction of the transmission line at the source and at the load．

## Connecting A Load Using A Transmission Line

In most cases，it is unrealistic to think that we can place a driver or buffer so close to the load that we don＇t need a transmission line to transport the signal．The pcb trace length between a driver and the load may affect operation depending upon the operating frequency．Sometimes it is possible to do measurements by connecting the DUT directly to the analyzer．As frequencies become higher the short lines from the DUT to the analyzer become long lines．When this happens there is a need to use transmission lines．The next point to examine is what happens when the load is connected to the transmission line．When driving a load，it is important to match the line and load impedance，otherwise reflections will occur and this phenomena will distort the signal．If a transient is applied at $\mathrm{T}=0$（Figure 6，trace A ）the resultant waveform may be observed at the start point of the transmission line．At this point（begin）on the transmission line the voltage increases to $(\mathrm{V})$ and the wave front travels along the transmission line and arrives at the load at $\mathrm{T}=10$ ． At any point across along the line $\mathrm{I}=\mathrm{V} / \mathrm{Z}_{0}$ ，where $\mathrm{Z}_{0}$ is the impedance of the transmission line．For an applied transient of 2 V with $\mathrm{Z}_{0}=50 \Omega$ the current from the buffer output stage is 40 mA ．Many vintage opamps cannot deliver this level of current because of an output current limitation of about 20 mA or even less．At $\mathrm{T}=10$ the wave front arrives at the load．Since the load is perfectly matched to the transmission line all of the current traveling across the line will be ab－ sorbed and there will be no reflections．In this case source and load voltages are exactly the same．When the load and the transmission line have unequal values of impedance a different situation results．Remember there is another basic which says that energy cannot be lost．The power in the transmission line is $\mathrm{P}=\mathrm{V}^{2} / \mathrm{R}$ ．In our example the total power is $2^{2} / 50=80 \mathrm{~mW}$ ．Assume a load of $75 \Omega$ ．In that case a power of 80 mW arrives at the $75 \Omega$ load and causes a voltage of the proper amplitude to maintain the incoming power．

## Application Notes <br> （Continued）

$$
\begin{equation*}
V=\sqrt{(P \times R)}=\sqrt{\left(80 \times 10^{-3} \times 75\right)}=2.45 \mathrm{~V} \tag{3}
\end{equation*}
$$

The voltage wavefront of 2.45 V will now set about traveling back over the transmission line towards the source，thereby resulting in a reflection caused by the mismatch．On the other hand if the load is less then $50 \Omega$ the backwards traveling wavefront is subtracted from the incoming voltage of 2 V ．Assume the load is $40 \Omega$ ．Then the voltage across the load is：

$$
\begin{equation*}
\left.\sqrt{\left(80 \times 10^{-3} \times 40\right.}\right)=1.79 \mathrm{~V} \tag{4}
\end{equation*}
$$

This voltage is now traveling backwards through the line toward the start point．In the case of a sinewave interfer－ ences develop between the incoming waveform and the backwards－going reflections，thus distorting the signal．If there is no load at all at the end point the complete transient of 2 V is reflected and travels backwards to the beginning of the line．In this case the current at the endpoint is zero and the maximum voltage is reflected．In the case of a short at the end of the line the current is at maximum and the voltage is zero．


FIGURE 6.

## Using Serial And Parallel Termination

Many applications，such as video，use a series resistance between the driver and the transmission line（see Figure 1）． In this case the transmission line is terminated with the characteristic impedance at both ends of the line．See Figure 6 trace $B$ ．The voltage traveling through the transmission line is half the voltage seen at the output of the buffer，because the series resistor in combination with $\mathrm{Z}_{0}$ forms a two－to－one voltage divider．The result is a loss of 6 dB ．For video appli－
cations，amplifier gain is set to 2 in order to realize an overall gain of 1 ．Many operational amplifiers have a relatively flat frequency response when set to a gain of two compared to unity gain．In trace B it is seen that，if the voltage reaches the end of the transmission line，the line is perfectly matched and no reflections will occur．The end point voltage stays at half the output voltage of the opamp or buffer．

## Driving More Than One Input

Another transmission line possibility is to route the trace via several points along a transmission line（Figure 2）This is only possible if care is taken to observe certain restrictions． Failure to do so will result in impedance discontinuities that will cause distortion of the signal．In the configuration of Figure 2 there is a transmission line connected to the buffer output and the end of the line is terminated with $Z_{0}$ ．We have seen in the section＇Connecting a load using a transmission line＇that for the condition above，the signal throughout the entire transmission line has the same value，that the value is the nominal value initiated by the opamp output，and no reflections occur at the end point．Because of the lack of reflections no interferences will occur．Consequently the sig－ nal has every where on the line the same amplitude．This allows the possibility of feeding this signal to the input port of any device which has high ohmic impedance and low input capacitance．In doing so keep in mind that the transient arrives at different times at the connected points in the transmission line．The speed of light in vacuum，which is about $3^{*} 10^{8} \mathrm{~m} / \mathrm{sec}$ ，reduces through a transmission line or a cable down to a value of about $2{ }^{*} 10^{8} \mathrm{~m} / \mathrm{sec}$ ．The distance the signal will travel in 1 ns is calculated by solving the following formula：

Where

$$
\begin{gathered}
\mathrm{S}=\mathrm{V}^{*} \mathrm{t} \\
\mathrm{~S}=\text { distance } \\
\mathrm{V}=\text { speed in the cable } \\
\mathrm{t}=\text { time }
\end{gathered}
$$

This calculation gives the following result：$s=2^{*} 10^{8 *} 1^{*} 10^{-9}$ $=0.2 \mathrm{~m}$
That is for each nanosecond the wave front shifts 20 cm over the length of the transmission line．Keep in mind that in a distance of just 2 cm the time displacement is already 100ps．

## Using Serial Termination To More Than One Transmission Line

Another way to reach several points via a transmission line is to start several lines from one buffer output（see Figure 3）． This is possible only if the output can deliver the needed current into the sum of all transmission lines．As can be seen in this figure there is a series termination used at the begin－ ning of the transmission line and the end of the line has no termination．This means that only the signal at the endpoint is usable because at all other points the reflected signal will cause distortion over the line．Only at the endpoint will the measured signal be the same as at the startpoint．Referring to Figure 6 trace C，the signal at the beginning of the line has a value of $\mathrm{V} / 2$ and at $\mathrm{T}=0$ this voltage starts traveling towards the end of the transmission line．Once at the end－ point the line has no termination and $100 \%$ reflection will occur．At T $=10$ the reflection causes the signal to jump to 2 V and to start traveling back along the line to the buffer（see Figure 6 trace D）．Once the wavefront reaches the series termination resistor，provided the termination value is $Z_{0}$ ，the wavefront undergoes total absorption by the termination． This is only true if the output impedance of the buffer／driver is low in comparison to the characteristic impedance $Z_{0}$ ．At

## Application Notes（Continued）

this moment the voltage in the whole transmission line has the nominal value of 2 V （see Figure 6 trace E）．If the three transmission lines each have a different length the particular point in time at which the voltage at the series termination resistor jumps to 2 V is different for each case．However，this transient is not transferred to the other lines because the output of the buffer is low and this transient is highly attenu－ ated by the combination of the termination resistor and the output impedance of the buffer．A simple calculation illus－ trates the point．Assume that the output impedance is $5 \Omega$ ． For the frequency of interest the attenuation is $V_{B} / V_{A}=55 / 5$ $=11$ ，where $A$ and $B$ are the points in Figure 3．In this case the voltage caused by the reflection is $2 / 11=0.18 \mathrm{~V}$ ．This voltage is transferred to the remaining transmission lines in sequence and following the same rules as before this volt－ age is seen at the end points of those lines．The lower the output resistance the higher the decoupling between the different lines．Furthermore one can see that at the endpoint of these transmission lines there is a normal transient equal to the original transient at the beginning point．However at all other points of the transmission line there is a step voltage at different distances from the startpoint depending at what point this is measured（see trace D）．

## Measuring The Length Of A Transmission Line

An open transmission line can be used to measure the length of a particular transmission line．As can be seen in Figure 7 the line of interest has a certain length．A transient is applied at $\mathrm{T}=0$ and at that point in time the wavefront starts traveling with an amplitude of $\mathrm{V} / 2$ towards the end of the line where it is reflected back to the startpoint．


FIGURE 7.
To calculate the length of the line it is necessary to measure immediately after the series termination resistor．The voltage at that point remains at half nominal voltage，thus $\mathrm{V} / 2$ ，until the reflection returns and the voltage jumps to V ．During an interval of 5 ns the signal travels to the end of the line where the wave front is reflected and returns to the measurement point．During the time interval when the wavefront is travel－ ing to the end of the transmission line and back the voltage has a value of $\mathrm{V} / 2$ ．This interval is 10 ns ．The length can be calculated with the following formula：$S=\left(V^{*} T\right) / 2$

$$
\begin{equation*}
S=\frac{\left(2 \times 10^{8}\right) \times\left(10 \times 10^{-9}\right)}{2}=1 \mathrm{mtr} \tag{5}
\end{equation*}
$$

As calculated before in the section＇Driving more than one input＇the signal travels $20 \mathrm{~cm} / \mathrm{ns}$ so in 5 ns this distance indicated distance is 1 m ．So this example is easily verified．

## APPLYING A CAPACITIVE LOAD

The assumption of pure resistance for the purpose of con－ necting the output stage of a buffer or opamp to a load is appropriate as a first approximation．Unfortunately that is only a part of the truth．Associated with this resistor is a capacitor in parallel and an inductor in series．Any capaci－ tance such as $\mathrm{C}_{\mathrm{L}}-1$ which is connected directly to the output stage is active in the loop gain as seen in Figure 8．Output capacitance，present also at the minus input in the case of a buffer，causes an increasing phase shift leading to instability or even oscillation in the circuit．


BUFFER INTERNAL CONNECTIONS
20064148

## FIGURE 8.

Unfortunately the leads of the output capacitor also contain series inductors which become more and more important at high frequencies．At a certain frequency this series capacitor and inductor forms an LC combination which becomes se－ ries resonant．At the resonant frequency the reactive com－ ponent vanishes leaving only the ohmic resistance（R－1 or $\mathrm{R}-2$ ）of the series L／C combination．（see Figure 9）．


FIGURE 9.
Consider a frequency sweep over the entire spectrum for which the LMH6559 high frequency buffer is active．In the first instance peaking occurs due to the parasitic capaci－ tance connected at the load whereas at higher frequencies the effects of the series combination of $L$ and $C$ become noticeable．This causes a distinctive dip in the output fre－ quency sweep and this dip varies depending upon the par－ ticular capacitor as seen in Figure 10.

## Application Notes

（Continued）


FIGURE 10.
To minimize peaking due to CL a series resistor for the purpose of isolation from the output stage should be used．A low valued resistor will minimize the influence of such a load capacitor．In a $50 \Omega$ system as is common in high frequency circuits a $50 \Omega$ series resistor is often used．Usage of the series resistor，as seen in Figure 11 eliminates the peaking but not the dip．The dip will vary with the particular capacitor． Using a resistor in series with a capacitor creates in a single pole situation a $6 \mathrm{~dB} /$ oct rolloff．However，at high frequencies the internal inductance is appreciable and forms a series LC combination with the capacitor．Choice of a higher valued resistor，for example 500 to $1 \mathrm{k} \Omega$ ，and a capacitor of hun－ dreds of pF ＇s provides the expected response at lower fre－ quencies．


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FIGURE 11.

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## USING GROUND PLANES

The use of ground planes is recommended both for provid－ ing a low impedance path to ground（or to one of the other supply voltages）and also for forming effective controlled impedance transmission lines for the high frequency signal flow on the board．Multilayer boards often make use of inner conductive layers for routing supply voltages．These supply voltage layers form a complete plane rather than using dis－ crete traces to connect the different points together for the specified supply．Signal traces on the other hand are routed on outside layers both top and bottom．This allows for easy access for measurement purposes．Fortunately，only very high density boards have signal layers in the middle of the board．In an earlier section，the formula for $Z_{0}$ was derived as：

$$
\begin{equation*}
Z=\frac{87}{\sqrt{(\varepsilon r+1.41)}} \times \ln \frac{(5.98 \times h)}{(0.8 W)} \tag{6}
\end{equation*}
$$

The width of a trace is determined by the thickness of the board．In the case of a multilayer board the thickness is the space between the trace and the first supply plane under this trace layer．By common practice，layers do not have to be evenly divided in the construction of a pcb．Refer to Figure 12．The design of a transmission line design over a pcb is based upon the thickness of the different internal layers and the $\epsilon_{\mathrm{r}}$ of the board material．The pcb manufacturer can supply information about important specifications．For ex－ ample，a nominal 1.6 mm thick pcb produces a $50 \Omega$ trace for a calculated width of 2.9 mm ．If this layer has a thickness of 0.35 mm and for the same $\epsilon_{\mathrm{r}}$ ，the trace width for $50 \Omega$ should be of 0.63 mm ，as calculated from Equation 7，a derivation from Equation 6.

$$
\begin{align*}
w & =\frac{5.98 \times h}{e^{A}} \\
\text { where } A & =\frac{\left[Z_{O} \times \sqrt{\left(\varepsilon_{r}+1.41\right.}\right)}{87} \tag{7}
\end{align*}
$$



FIGURE 12.
Using a trace over a ground plane has big advantages over the use of a standard single or double sided board．The main advantage is that the electric field generated by the signal transported over this trace is fixed between the trace and the ground plane e．g．there is almost no possibility of radiation （seeFigure 13）．

## Application Notes（Continued）



GROUNDPLANE
20064155

## FIGURE 13.

This effect works to both sides because the circuit will not generate radiation but the circuit is also not sensible if ex－ posed to a certain radiation level．The same is also notice－ able when placing components flat on the printed circuit board．Standard through hole components when placed up－ right can act as an antenna causing an electric field which could be picked up by a nearby upright component．If placed directly at the surface of the pcb this influence is much lower．

## The Effect Of Variation For $\epsilon_{\mathrm{r}}$

When using pcb material the $\epsilon_{\mathrm{r}}$ has a certain shift over the used frequency spectrum，so if necessary to work with very accurate trace impedances one must taken into account for which frequency region the design has to be functional． Figure 14 （http：／／www．isola．de）gives an example what the drift in $\epsilon_{\mathrm{r}}$ will be when using the pcb material produced by Isola．If working at frequencies of 100 MHz then a $50 \Omega$ trace has a width of 3.04 mm for standard 1.6 mm FR4 pcb mate－ rial，and the same trace needs a width of 3.14 mm ．for frequencies around 10 GHz ．


FIGURE 14.

## Routing Power Traces

Power line traces routed over a pcb should be kept together for best practice．If not a ground loop will occur which may cause more sensitivity to radiation．Also additional ground trace length may lead to more ringing on digital signals．

Careful attention to power line distribution leads to improved overall circuit performance．This is especially valid for analog circuits which are more sensitive to spurious noise and other unwanted signals．


FIGURE 15.
As demonstrated in Figure 15 the power lines are routed from both sides on the pcb．In this case a current loop is created as indicated by the dotted line．This loop can act as an antenna for high frequency signals which makes the circuit sensitive to $R_{F}$ radiation．A better way to route the power traces can be seen in the following setup．（see Figure 16）


FIGURE 16.
In this arrangement the power lines have been routed in order to avoid ground loops and to minimize sensitivity to noise etc．The same technique is valid when routing a high frequent signal over a board which has no ground plane．In that case is it good practice to route the high frequency signal alongside a ground trace．A still better way to create a pcb carrying high frequency signals is to use a pcb with a ground plane or planes．

## Application Notes（Continued）

## Discontinuities In A Ground Plane

A ground plane with traces routed over this plane results in the build up of an electric field between the trace and the ground plane as seen in Figure 13．This field is build up over the entire routing of the trace．For the highest performance the ground plane should not be interrupted because to do so will cause the field lines to follow a roundabout path．In Figure 17 it was necessary to interrupt the ground plane with a crossing trace．This interruption causes the return current to follow a longer route than the signal path follows to overcome the discontinuity．


## FIGURE 17.

If needed it is possible to bypass the interruption with traces that are parallel to the signal trace in order to reduce the negative effects of the discontinuity in the ground plane．In doing so，the current in the ground plane closely follows the signal trace on the return path as can be seen in Figure 18. Care must be taken not to place too many traces in the ground plane or the ground plane effectively vanishes such that even bypasses are unsuccessful in reducing negative effects．


FIGURE 18.

## Application Notes

design have at least one ground plane on a pcb which provides a low impedance path for all decoupling capacitors and other ground connections．Care should be taken espe－ cially that on－board transmission lines have the same im－ pedance as the cables to which they are connected $-50 \Omega$ for most applications and $75 \Omega$ in case of video and cable TV applications．Such transmission lines usually require much wider traces on a standard double sided PCB board than needed for a＇normal＇trace．Another important issue is that inputs and outputs must not＇see＇each other．This occurs if inputs and outputs are routed together over the pcb with only a small amount of physical separation，particularly when there is a high differential in signal level between them． Furthermore components should be placed as flat and low as possible on the surface of the PCB．For higher frequen－ cies a long lead can act as a coil，a capacitor or an antenna． A pair of leads can even form a transformer．Careful design of the pcb avoids oscillations or other unwanted behaviors． For ultra high frequency designs only surface mount compo－ nents will give acceptable results．（for more information see OA－15）．
NSC suggests the following evaluation boards as a guide for high frequency layout and as an aid in device testing and characterization．

| Device | Package | Evaluation Board <br> Part Number |
| :--- | :--- | :--- |
| LMH6559MA | SOIC－8 | CLC730245 |
| LMH6559MAX | SOIC－8 | CLC730245 |
| LMH6559MF | SOT23－5 | CLC730136 |
| LMH6559MFX | SOT23－5 | CLC730136 |

These free evaluation boards are shipped when a device sample request is placed with National Semiconductor．

## POWER SEQUENCING OF THE LMH6559

Caution should be exercised in applying power to the LMH6559．When the negative power supply pin is left float－ ing it is recommended that other pins，such as positive supply and signal input should also be left unconnected．If the ground is floating while other pins are connected the input circuitry is effectively biased to ground，with a mostly low ohmic resistor，while the positive power supply is ca－ pable of delivering significant current through the circuit．This causes a high input bias current to flow which degrades the input junction．The result is an input bias current which is out of specification．When using inductive relays in an applica－ tion care should be taken to connect first both power con－ nections before connecting the bias resistor to the input．

$$
\begin{aligned}
& \text { 勝 特 力材 料 886-3-5753170 } \\
& \text { 胜特力电子(上海) 86-21-34970699 } \\
& \text { 胜特力电子(深圳) 86-755-83298787 } \\
& \text { Http://www. } 100 \mathrm{y} . \mathrm{com} . \mathrm{tw}
\end{aligned}
$$

Physical Dimensions inches（millimeters）unless othervise noted



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